



High Conductivity Structural Floorboard



Product Information

HiDECK Structural is a conductive structural floorboard ideal for acoustic batten & cradle and batten applications incorporating an underfloor heating system. The board's low thermal resistance enables the system to operate more efficiently, providing long term running cost savings.

Product Benefits

- Outstanding performance Robust Detail proprietary structural board for FFT1, 2 & 3
- O Low thermal resistance Perfect for UFH applications
- O Suitable for all types of steel, concrete and timber floors
- Feels like screed

Technical Information

		HiDECK Structural		
		25	28	30
Product desciption	-	Tongue and groove, high density gypsum, low thermal resistance structural floorboard		
Thickness'	mm	25	28	30
Thermal resistance	-	0.0625	0.070	0.075
Bearing spacing (45mm wide)	mm	400 (max) centers	400 (max) centers	400 (max) centers
Board dimensions	mm	600 x 1200	600 x 1200	600 x 1200
Weight	kg/m² kg/board	31.25 10.74	35.00 19.29	37.50 23.32
Associated flanking strip required	-	YELO fon ES5/120	YELO fon ES5/120	YELO fon ES5/120

Third Party Accreditation and Approvals









Environmental Credentials













